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STD10NF10 STD10NF10-1

N-channel 100V - 0.115Ω - 13A - DPAK - IPAK Low gate charge STripFET™ II Power MOSFET

General features

Туре	V _{DSSS}	R _{DS(on)}	I _D
STD10NF10	100V	<0.13Ω	13A
STD10NF10-1	100V	<0.13Ω	13A

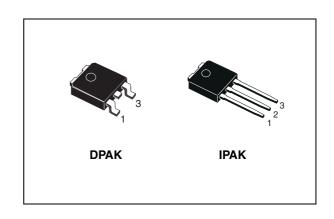
- Exceptional dv/dt capability
- Application oriented characterization

Description

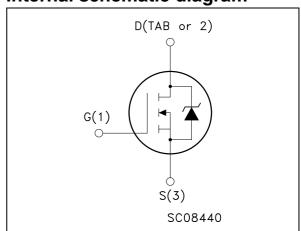
This MOSFET series realized with STMicroelectronics unique STripFET process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced highefficiency, high-frequency isolated DC-DC converters for Telecom and Computer applications. It is also intended for any applications with low gate drive requirements.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STD10NF10T4	D10NF10	DPAK	Tape & reel
STD10NF10-1	D10NF10	IPAK	Tube

Contents STD10NF10

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STD10NF10 Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	100	V
V _{DGR}	Drain-gate voltage ($R_{GS} = 20K\Omega$)	100	V
V _{GS}	Gate-source voltage	± 20	V
I _D	Drain current (continuous) at $T_C = 25^{\circ}C$	13	Α
I _D	Drain current (continuous) at T _C =100°C	9	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	52	Α
P _{TOT}	Total dissipation at T _C = 25°C	50	W
	Derating factor	0.33	W/°C
E _{AS} (2)	Single pulse avalanche energy	70	mJ
dv/dt (3)	Peak diode recovery voltage slope	9	V/ns
T _{stg}	Storage temperature	-55 to 175	
TJ	Max. operating junction temperature	-55 to 175	°C

^{1.} Pulse width limited by safe operating area

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance junction-case Max	3.0	°C/W
R _{thJA}	Thermal resistance junction-ambient Max	100	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

^{2.} Starting $T_J = 25$ °C, $I_D = 15A$, $V_{DD} = 50V$

^{3.} $I_{SD} \le 13A$, di/dt ≤ 300 A/ μ s, $V_{DS} \le V_{(BR)DSS}$, $T_J \le T_{JMAX}$

Electrical characteristics STD10NF10

2 Electrical characteristics

(T_{CASE} = 25°C unless otherwise specified)

Table 3. On /off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250\mu A, V_{GS} = 0$	100			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} = Max rating, T_{C} = 125°C			1 10	μΑ μΑ
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ±20V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10V, I _D = 5A		0.115	0.13	Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} = 15V_{,} I_{D} = 5A$		20		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25V, f = 1 \text{ MHz},$ $V_{GS} = 0$		460 70 30		pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 80V, I_{D} = 10A$ $V_{GS} = 10V$		15.3 3.7 4.7	21	nC nC nC

^{1.} Pulsed: pulse duration=300µs, duty cycle 1.5%

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$t_{d(on)}$ t_{r} $t_{d(off)}$ t_{f}	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} = 27V, I_D = 5A, R_G = 4.7 Ω , V_{GS} = 10V Figure 13 on page 8		16 25 32 8		ns ns ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				13	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				52	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 10A, V_{GS} = 0$			1.5	٧
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 10A, di/dt = 100A/ μ s, V_{DD} = 50V, T_{J} = 150°C Figure 15 on page 8		90 230 5		ns μC A

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: pulse duration=300µs, duty cycle 1.5%

Electrical characteristics STD10NF10

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

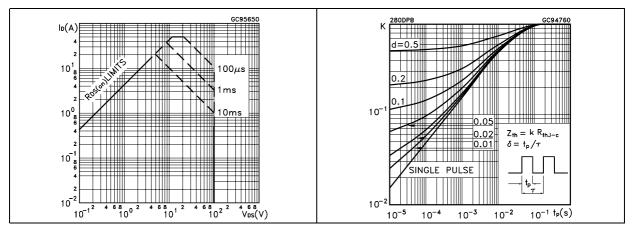


Figure 3. Output characterisics

Figure 4. Transfer characteristics

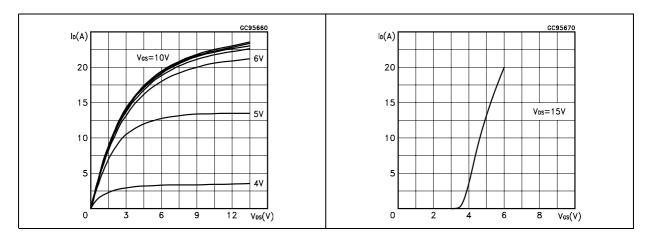
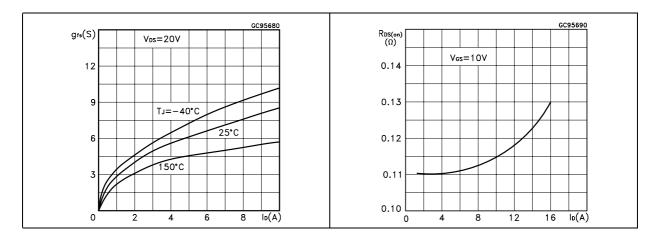


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



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Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

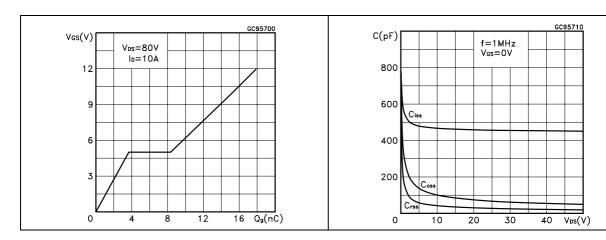


Figure 9. Normalized gate threshold voltage vs temperature

Figure 10. Normalized on resistance vs temperature

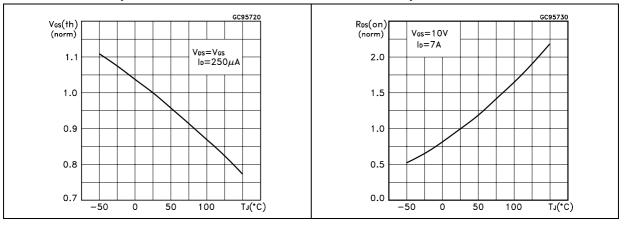
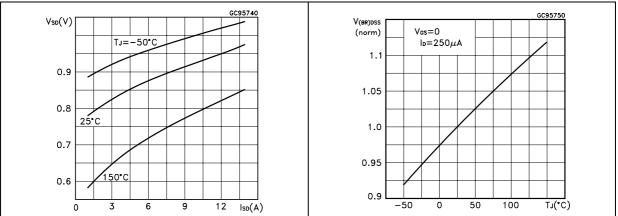


Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized breakdown voltage vs temperature



Test circuit STD10NF10

3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

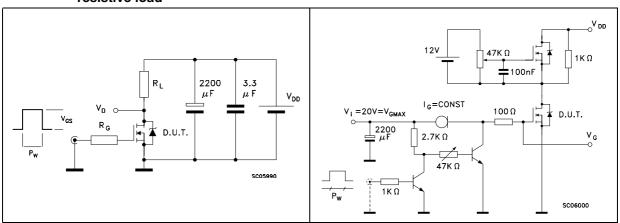


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

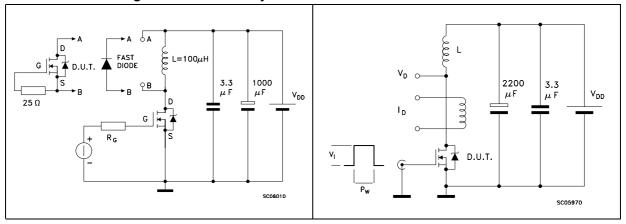
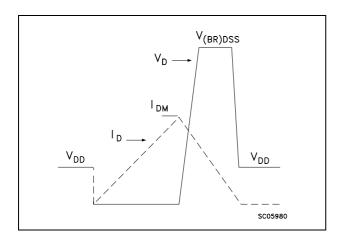


Figure 17. Unclamped inductive waveform



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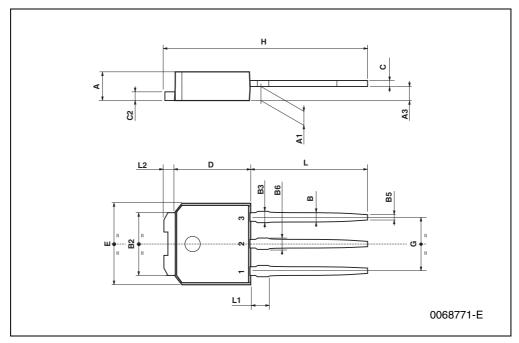
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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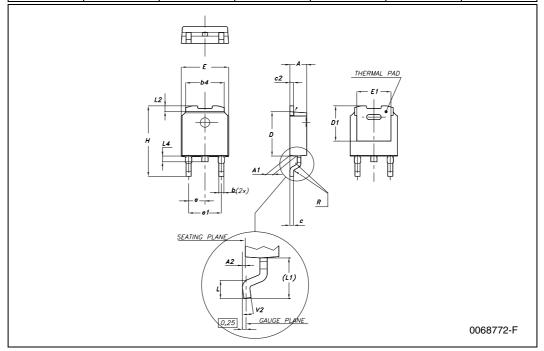
TO-251 (IPAK) MECHANICAL DATA

DIM.		mm			inch	
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	2.2		2.4	0.086		0.094
A1	0.9		1.1	0.035		0.043
А3	0.7		1.3	0.027		0.051
В	0.64		0.9	0.025		0.031
B2	5.2		5.4	0.204		0.212
В3			0.85			0.033
B5		0.3			0.012	
B6			0.95			0.037
С	0.45		0.6	0.017		0.023
C2	0.48		0.6	0.019		0.023
D	6		6.2	0.236		0.244
E	6.4		6.6	0.252		0.260
G	4.4		4.6	0.173		0.181
Н	15.9		16.3	0.626		0.641
L	9		9.4	0.354		0.370
L1	0.8		1.2	0.031		0.047
L2		0.8	1		0.031	0.039



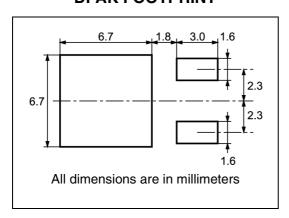
DPAK MECHANICAL DATA

DIM		mm.		inch		
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	2.2		2.4	0.086		0.094
A1	0.9		1.1	0.035		0.043
A2	0.03		0.23	0.001		0.009
В	0.64		0.9	0.025		0.035
b4	5.2		5.4	0.204		0.212
С	0.45		0.6	0.017		0.023
C2	0.48		0.6	0.019		0.023
D	6		6.2	0.236		0.244
D1		5.1			0.200	
E	6.4		6.6	0.252		0.260
E1		4.7			0.185	
е		2.28			0.090	
e1	4.4		4.6	0.173		0.181
Н	9.35		10.1	0.368		0.397
L	1			0.039		
(L1)		2.8			0.110	
L2		0.8			0.031	
L4	0.6		1	0.023		0.039
R		0.2			0.008	
V2	0°		8°	0°		8°

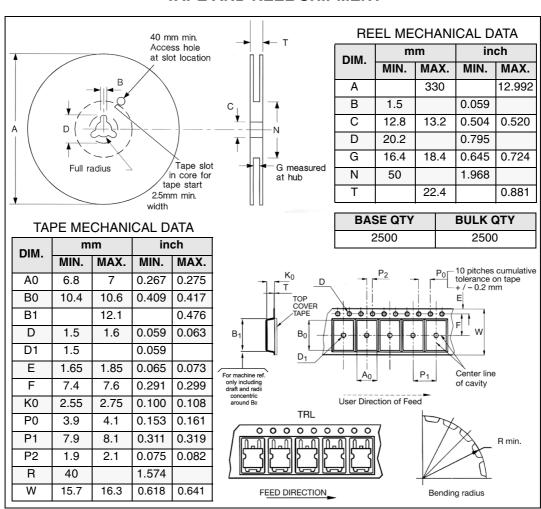


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5 Packaging mechanical data DPAK FOOTPRINT



TAPE AND REEL SHIPMENT



STD10NF10 Revision history

6 Revision history

Table 7. Revision history

Date	Revision	Changes
09-Sep-2004	3	Complete version
07-Aug-2006	3	New template, updated SOA

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